INFORMATION FOR AUTHORS

The IEEE EMC Society is seeking original, unpublished papers covering all aspects of electromagnetic compatibility, signal integrity and power integrity including design, modeling, measurements, management and education.

Conference proceedings will be submitted for posting to IEEE Xplore. In addition, authors of accepted papers will be invited to submit an extended version of their symposium paper for possible publication in a special issue of the IEEE Transactions on Electromagnetic Compatibility.

PAPER TOPICS OF INTEREST

Topics include but are not limited to the following technical areas

TC-1 EMC Management
- Personnel & Laboratory Accreditation
- EMC Education
- Legal Issues

TC-2 EMC Measurements
- Test Instrumentation & Facilities
- Measurement Techniques
- Standards and Regulations

TC-3 EM Environment
- EM Signal Environment
- Atmospheric & Man-Made Noise

TC-4 EM Interference Control
- Shielding, Gasketing & Filtering
- Cables and Connectors
- Circuit & System EMC Analysis
- Grounding

TC-5 High Power Electromagnetics
- ESD & Transients
- EMP, IEMI & Lightning
- Information Leakage
- Electric Power EMC

TC-6 Spectrum Engineering
- Spectrum characterization and modeling
- Design for spectrally efficient systems
- Adaptive interference mitigation

TC-7 Low Frequency EMC
- Power Quality and Conducted EMC
- Power Electronics

TC-9 Computational Electromagnetics
- Computer Modeling Methods
- Tools and Techniques
- Validation Methods
- Statistical Analysis

TC-10 Signal and Power Integrity - embedded 2019 IEEE International Conference on Signal and Power Integrity (SIPI 2019)
- High-speed link/bus design
- Power integrity analysis and design
- Passive component modeling and measurement techniques
- Jitter/Noise modeling and analysis
- SI/PI/EMC co-simulation and co-design
- Numerical modeling and simulation techniques
- 2.5D/3D/Exotic ICs and emerging technologies
- IOT

TC-11 Nanotechnology & Advanced Materials
- Nanomaterials & Nanostructures
- Smart Materials

TC-12 EMC for Emerging Wireless Technologies
- EMC Planning/Testing/Specifications
- Wireless Coexistence
- Intra-System Interference

SC-1 Smart Grid EMC
- RF Environment
- Performance Degradation

SC-5 Power Electronics EMC
- Power Electronics Converters EMI/EMC Issues
- Switching Frequency Schemes
- Inverters

SC-6 Unmanned Aircraft Systems EMC
- Spectrum Management on Intra and Inter-System Interactions
- Design, Testing, Modeling/Simulation Required for System Level EMC for Unmanned Aircraft Systems
- Robust Performance in the Presence of High Intensity Radiated Fields (HIRF)

SC-7 Aeronautics and Space EMC
- EMI/EMC issues in Aircraft, Spacecraft & Space Launch Vehicles, Robotic and Crewed
- EMC Analysis, Design, Test and Performance of Space Systems
- Part, Board, Box, System, Multi-system, Planetary and Interplanetary Levels
- Launch and Space Environments
- SDECom Standards Development and Education Committee
- Standards in Development
- Critical Updates for Published Standards
- Topics for Future Standardization

WWW.EMC2019.EMCSS.ORG
STUDENT PAPER CONTEST

Graduate and undergraduate authors are eligible for the Best Student Paper contest. The student must be the primary author and should indicate that they wish to be considered for the contest when submitting the preliminary manuscript. Each student’s professor will be asked to certify that the paper is primarily the work of the student. A Student Design Contest is also being held.

Obtain the design kit, rules, and award details from the website: www.emc2019.emcss.org

SPECIAL ISSUES OF IEEE TRANSACTIONS ON EMC

Authors of accepted papers will be invited to submit an extended version of their symposium paper for possible inclusion in a special issue of the IEEE Transactions on Electromagnetic Compatibility featuring papers from the 2019 IEEE International Symposium on Electromagnetic Compatibility, Signal Integrity and Power Integrity. These submissions will be subjected to the same rigorous review as papers submitted for publication in regular issues of the IEEE Transactions on EMC.

GUIDELINES FOR AUTHORS & SUBMITTAL PROCEDURES

Prospective authors must submit electronically**.

• A preliminary manuscript (4 – 6 pages) including all relevant results and conclusions.
• Choice of presentation format (traditional oral or poster paper)

** Preliminary manuscripts and final papers are to be submitted using the link provided on the symposium website at www.emc2019.emcss.org beginning October 1, 2018. During the electronic submission process a unique author code is created for tracking purposes. Submissions are reviewed anonymously; please do not include author names or affiliations on the Preliminary Manuscript. Failure to comply with submission requirements may result in rejection.

PAPER ACCEPTANCE PROCEDURES & CRITERIA

Importance of Topic: Does it have direct significance to the EMC and/or SI/PI community?

Technical Sophistication and Depth: Does it present information that is a significant contribution, advancement, application or refinement of the state of the art? Does it expose the reader to a higher knowledge level than currently available from other sources?

Readability, Clarity and Presentation: Is the value of the submission clearly defined? Is the material written in clear and concise English, with topics presented in an organized and logical manner?

Novelty and Originality: Does it propose a new and unique concept or expand on an existing premise from a unique point of view?